

S	PECIFICATIONS	
CUSTOMER		
SAMPLE CODE	SH240320T-0	63-L-Q
MASS PRODUCTION CODE	· PH240320T-0	63-L-Q
SAMPLE VERSION	· 01	
SPECIFICATIONS EDITION	· 003	
DRAWING NO. (Ver.)	·LMD-PH24032	20T-063-L-Q (Ver:001)
PACKAGING NO. (Ver.)	· PKG-PH24032	20T-063-L-Q (Ver:001)
Cu	stomer Approved	
	[Date:
Approved	Checked	Date: Designer
Approved 廖志豪 Rex Liao		
廖志豪 Rex Liao □ Preliminary specification fo ■ Specification for sample ap	Checked 廖志豪 Rex Liao	Designer 張慶源 Yuan Chang PowerTiP 2013.07.10 TW RD APR



History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
2012/08/06	01	001	New Drawing	-	Yuan
2012/11/01	01	002	New Sample	-	Yuan
2013/07/08	01	003	Modify Optical Characteristics	6	Yuan
					otal: 28 Page

Total: 28 Page



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Note : For detailed information please refer to IC data sheet :

Primacy(TFT LCD): ILITEK: ILI9341



1. SPECIFICATIONS

1.1 Features

Main LCD panel

Item	Standard Value
Display Type	240(R \ G \ B) * 320 Dots
LCD Type	Normally white, Transmissive type
Screen size(inch)	2.8 inch
Viewing Direction	12 O'clock
Color configuration	RGB-Strip
Backlight	LED Backlight
Interface	16-bit 80-system I/F
Other(controller/driver IC)	ILITEK: ILI9341
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news.php?area id view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	50.0(W) * 69.2 (L) * 3.05 (H)max	mm

LCD panel

Item	Standard Value	Unit
Active Area	43.2 (W) * 57.6 (L)	mm





1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
	VCC	-	-0.3	+4.6	V
System Power Supply Voltage	VGH ~ VGL	-	-0.3	+32	V
Input Voltage	VIN	-	-0.3	VCC+0.3	V
Operating Temperature	T _{OP}	-	-20	+70	°C
Storage Temperature	T _{ST}	-	-30	+80	°C
Storage Humidity	H_{D}	Ta 40 °C	20	90	%RH

1.4 DC Electrical Characteristics

Module

GND = 0V, Ta = 25°C

Module					J = 0V, 1a -	20 0
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage1	VCC	-		2.8	-	V
Input High Voltage	V _{IH}	-	0.7 VCC	-	VCC	V
Input Low Voltage	VIL	-	GND	-	0.3 VCC	V
Output High Voltage	V _{OH}	IOH=-0.1mA	0.8*VDD	-	VDD	V
Output Low Voltage	V _{OL}	IOL=0.1mA	GND	-	0.2*VDD	V
Supply Current	ICC	VCC = 2.8V Pattern=full display *1	-	9	12	mA

Note1:Maximum current display





1.5 Optical Characteristics

TFT LCD Module

VCC = 2.8V, Ta=25°C

							-	
Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response tim	ne	Tr+ Tf	Ta = 25°C θX, θY = 0°	-	31	47	ms	Note2
	Тор	θY+		-	50	-		
Viewing angle	Bottom	θY-	CR ≥ 10	-	50	-	Deg.	Note4
	Left	θX-		-	50	-	Dey.	NOIE4
	Right	θX+		-	50	ľ		
Contrast ratio	0	CR	Ta = 25°C θX , θY = 0°	500	600	-	I	Note3
	White	Х		0.25	0.30	0.35		
	vviile	Y		0.28	0.33	0.38		
	Ded	Х		0.58	0.63	0.68		
Color of CIE Coordinate	Red	Y		0.3	0.35	0.4		
(With B/L)	Green	Х	-	0.29	0.34	0.39	_	
(,	Green	Y		0.56	0.61	0.66		
	Blue	Х		0.09	0.14	0.19		Note1
	Diue	Y		0.02	0.07	0.12		
Average Brightr	ness							
Pattern=white dis	splay	IV	IF=80 mA	230	255	-	cd/m ²	
(With B/L) *′	1							
Uniformity (With B/L)*2	2	∆B	IF=80 mA	70	-	-	%	

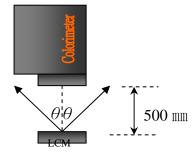
Note 1:

*1 : △B=B(min) / B(max) * 100%

*2 : Measurement Condition for Optical Characteristics:

- a : Environment: 25 ±5 / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
- b : Measurement Distance: 500 ± 50 mm \rightarrow (θ = 0°)
- c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
- d: The uncertainty of the C.I.E coordinate measurement ±0.01 · Average Brightness ± 4%





Colorimeter=BM-7 fast

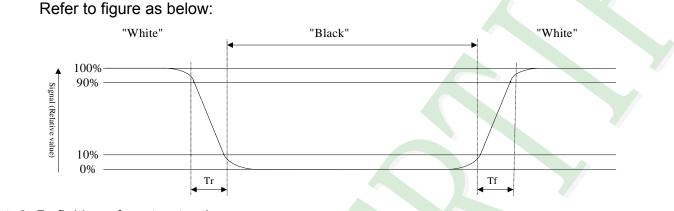
To be measured at the center area of panel with a viewing cone of 1° by Topcon



luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

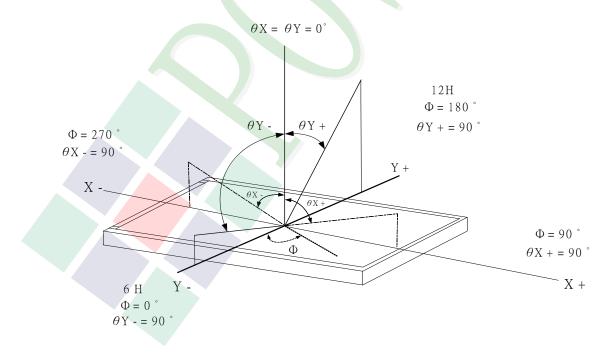
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





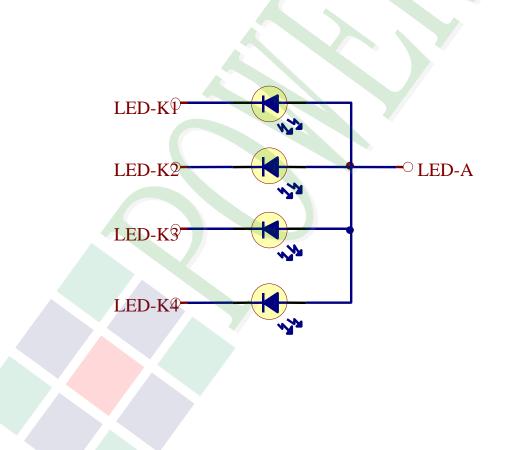
1.6 Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Power Dissipation	PD	Ta =25 ℃		0.288	W

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		2.8	_	3.6	V
Average Brightness (without LCD)	IV	IF= 80 mA	5000	5500	-	cd/m ²
CIE Color Coordinate	Х		0.26	0.28	0.33	
(Without LCD)	Y		0.26	0.28	0.33	-
Color			White		~	

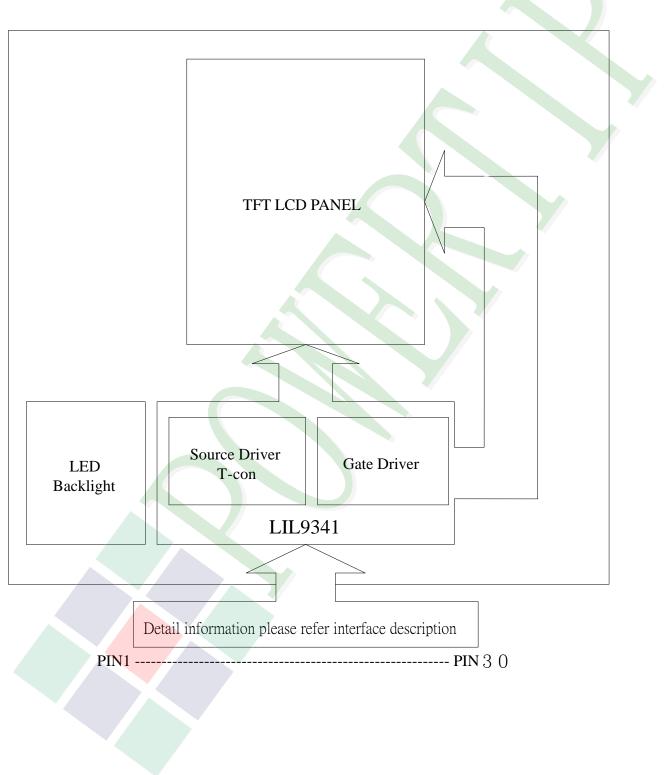




2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

- * See Appendix
- 2.1.2 Block Diagram





2.2 Interface Pin Description

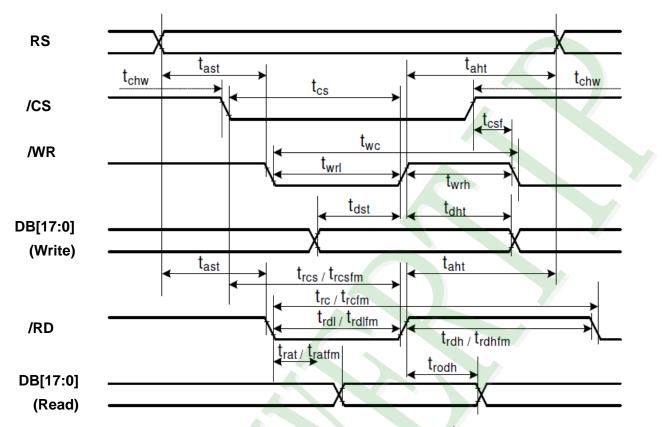
Pin No.	Symbol	Function
1	LEDK1-4	Power supply for LED Backlight Cathode input
2	LEDA	Power supply for LED Backlight Anode input
3	GND	Signal ground.(0V)
4	RESET	Reset input pin for TFT LCD. When RESET is "L", initialization is executed.
5	DB17	
6	DB16	
7	DB15	
8	DB14	
9	DB13	
10	DB12	
11	DB11	
12	DB10	Bi-directional data bus
13	DB8	
14	DB7	
15	DB6	
16	DB5	
17	DB4	
18	DB3	
19	DB2	
20	DB1	
21	RD	Read signal input - active at Low.
22	WR/SCL	Write signal input , active at Low.
23	RS	When RS = 0: Command. When RS = 1: Display data.
24	CS	Chip select signal , Active at "L"
25	XR/X+	NC



Pin No.	Symbol	Function
26	YD/Y-	
27	XL/X-	NC
28	YU/Y+	
29	GND	Signal ground.(0V)
30	2.8 /VCC	Power supply for the internal logic circuit.



2.3 Timing Characteristics

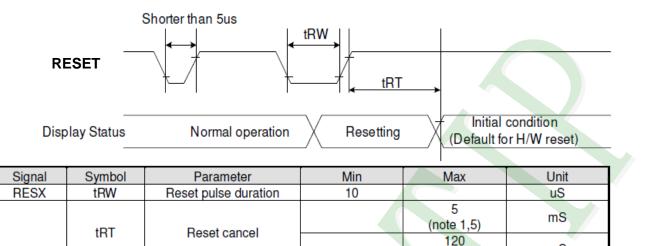


Signal	Symbol	Parameter	min	max	Unit	Description
RS	tast	Address setup time	0	-	ns	
кэ	taht	Address hold time (Write/Read)	0	-	ns	
	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
/CS	trcs	Chip Select setup time (Read ID)	45	-	ns	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
	twc	Write cycle	66	-	ns	
/WR	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
	trcfm	Read Cycle (FM)	450	-	ns	
/RD(FM)	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
	trc	Read cycle (ID)	160	-	ns	
/RD(ID)	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
DB[17:0]	tdst	Write data setup time	10	-	ns	
DB[17:0] DB[17:0] DB[8:0] DB[7:0]	tdht	Write data hold time	10	-	ns	For maximum CL=30pF
	trat	Read access time	-	40	ns	For minimum CL=30pF
	tratfm	Read access time	-	340	ns	
	trod	Read output disable time	20	80	ns	

Note: Ta = -30 to 70 °C, VCC=1.65V to 3.3V, VCI=2.5V to 3.3V, GND=0V



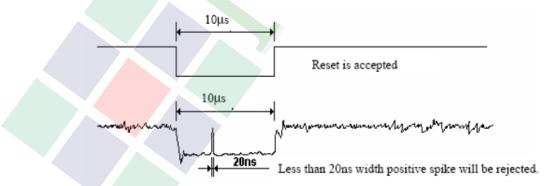
Reset Timing



- Note 1: The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NV memory to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
- Note 2: Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below: -

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

- Note 3: During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In -mode.) And then return to Default condition for Hardware Reset.
- Note 4: Spike Rejection also applies during a valid reset pulse as shown below:



Note 5: When Reset applied during Sleep In Mode.

- Note 6: When Reset applied during Sleep Out Mode.
- Note 7: It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

mS

(note 1.6.7)



2.4 Reference Initial code

MOV	ADDRH,#00H
MOV	ADDRL,#CBH
CALL	WRITE_COMMAND
MOV	ADDRL,#39H
CALL	WRITE_DATA
MOV	ADDRL,#2CH
CALL	WRITE_DATA
MOV	ADDRL,#00H
CALL	WRITE_DATA
MOV	ADDRL,#34H
CALL	WRITE_DATA
MOV	ADDRL,#02H
CALL	WRITE_DATA
MOV	ADDRL,#CFH
CALL	WRITE_COMMAND
MOV	ADDRL,#00H
CALL	WRITE_DATA
MOV	ADDRL,#C1H
CALL	WRITE_DATA
MOV	ADDRL,#30H
CALL	WRITE_DATA
MOV	ADDRL,#E8H
CALL	WRITE_COMMAND
MOV	ADDRL,#85H
CALL	WRITE_DATA
MOV	ADDRL,#00H
CALL	WRITE_DATA
MOV	ADDRL,#78H
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#EAH
CALL	WRITE_COMMAND
MOV	ADDRL,#00H
CALL	WRITE_DATA
MOV	ADDRL,#00H
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#EDH
CALL	WRITE_COMMAND
MOV	ADDRL,#64H
CALL	WRITE_DATA
MOV	ADDRL,#03H
CALL	WRITE_DATA
MOV	ADDRL,#12H
CALL	WRITE_DATA
MOV	ADDRL,#81H
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#F7H
CALL	WRITE_COMMAND
MOV	ADDRL,#20H
CALL	WRITE_DATA



MOV	ADDRH,#00H
MOV	ADDRL,#C0H
CALL	WRITE_COMMAND
MOV	ADDRL,#23H
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#C1H
CALL	WRITE_COMMAND
MOV	ADDRL,#10H
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#C5H
CALL	WRITE_COMMAND
MOV	ADDRL,#2BH
CALL	WRITE_DATA
MOV	ADDRL,#2BH
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#C7H
CALL	WRITE_COMMAND
MOV	ADDRL,#C0H
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#36H
CALL	WRITE_COMMAND
MOV	ADDRL,#40H
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#B1H
CALL	WRITE_COMMAND
MOV	ADDRL,#00H
CALL	WRITE_DATA
MOV	ADDRL,#1BH
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#B6H
CALL	WRITE_COMMAND
MOV	ADDRL,#0AH
CALL	WRITE_DATA
MOV	ADDRL,#02H
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#F2H
CALL	WRITE_COMMAND
MOV	ADDRL,#00H
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#26H
CALL	WRITE_COMMAND
MOV	ADDRL,#01H



CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#3AH
CALL MOV	WRITE COMMAND
MOV	ADDRL,#55H
CALL	WRITE_DATA
MOV	
MOV MOV	ADDRH,#00H ADDRL,#21H
CALL	WRITE COMMAND
CALL	
MOV	ADDRH,#00H
MOV	ADDRL,#E0H
CALL	WRITE COMMAND
MOV	ADDRL,#0FH
CALL	WRITE_DATA
MOV	ADDRL,#31H
	WRITE DATA
CALL	
MOV	ADDRL,#2BH
CALL	WRITE_DATA
MOV	ADDRL,#0CH
CALL	WRITE_DATA
MOV	ADDRL,#0EH
CALL	WRITE_DATA
MOV	ADDRL,#08H
CALL	WRITE_DATA
MOV	ADDRL,#4EH
CALL	WRITE_DATA
MOV	ADDRL,#F1H
CALL	WRITE_DATA
MOV	ADDRL,#37H
CALL	WRITE_DATA
MOV	ADDRL,#07H
CALL	WRITE_DATA
MOV	ADDRL,#10H
CALL	WRITE_DATA
MOV	ADDRL,#03H
CALL	
MOV	ADDRL,#0EH
CALL	WRITE DATA
MOV	ADDRL,#09H
CALL	WRITE DATA
MOV	ADDRL,#00H
CALL	WRITE_DATA
MOV	ADDRH,#00H
MOV	ADDRL,#E1H
CALL	WRITE_COMMAND
MOV	ADDRL,#00H
CALL	WRITE_DATA
MOV	ADDRL,#0EH
CALL	WRITE_DATA
MOV	ADDRL,#14H
CALL	WRITE_DATA
MOV	ADDRL,#03H
CALL	WRITE_DATA
MOV	ADDRL,#11H
	,



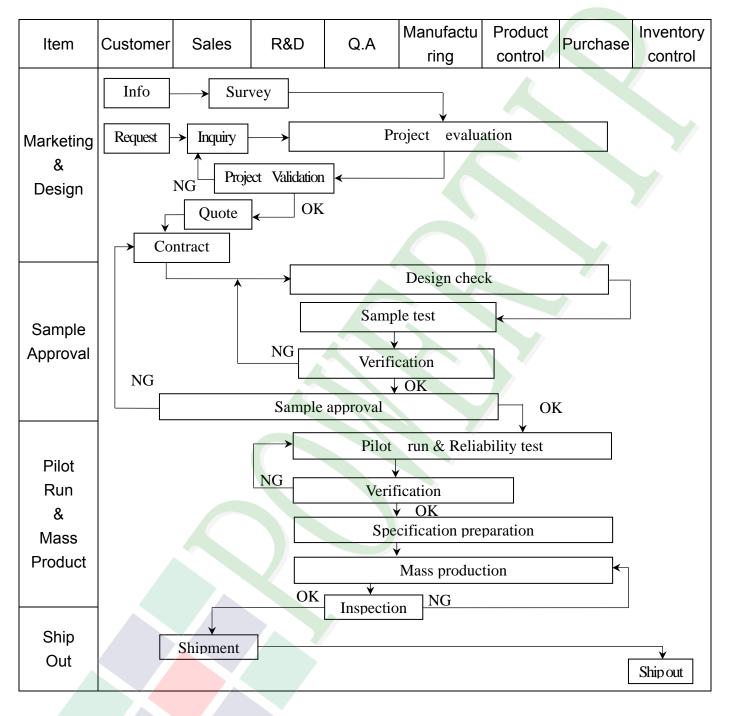
CALL	WRITE_DATA
MOV	
CALL	
CALL MOV	ADDRL,#31H
CALL	WRITE_DATA
MOV	ADDRL,#C1H
CALL	WRITE_DATA
MOV	
CALL	
MOV	ADDRL,#08H
CALL	WRITE_DATA
MOV	ADDRL,#0FH
CALL	WRITE DATA
MOV	ADDRL,#0CH
CALL	ADDRL,#0CH WRITE_DATA
MOV	VUDDI #310
CALL	WRITE_DATA
MOV	ADDRL,#36H
CALL	WRITE_DATA
MOV	ADDRL,#0FH
CALL	
MOV	ADDRH,#00H
MOV	•
CALL	
CALL	DELAY
CALL	DELAY
CALL	DELAY
	DELAY

MOV	ADDRH,#00H
MOV	ADDRL,#29H
CALL	WRITE_COMMAND



3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



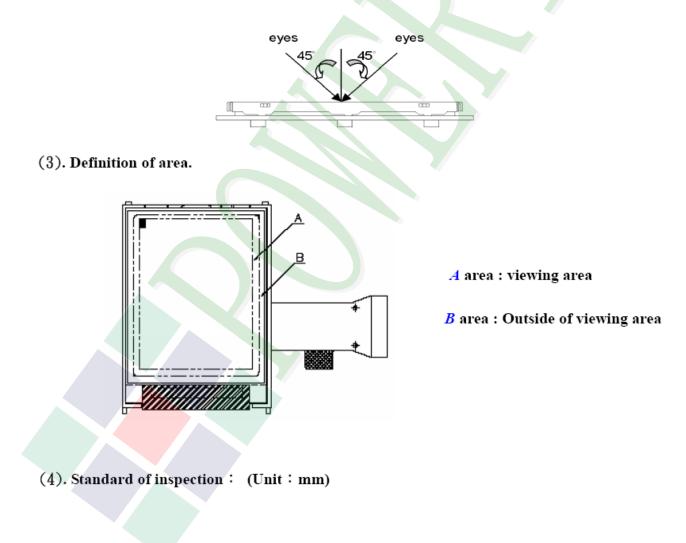


Item	Customer	Sales	R&D	Q.A	Manufact uring	Product control	Purchase	Inventory control
Sales Service	Info	→ Claim sis report	[Trackin	Failure an Corrective			
Q.A Activity	1. ISO 900 3. Equipme 5. Standard	ent calibrat	ion	4	Process in Education		nt proposal ing Activitie	es

POWERTIP

3.2 Inspection Specification

- \clubsuit Scope : The document shall be applied to TFT-LCD Module for less than 3.5" (Ver.B01).
- ◆Inspection Standard:MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample
- ◆Defect Level : Major Defect AQL : 0,4 ; Minor Defect AQL : 1,5
- ♦OUT Going Defect Level : Sampling.
- ◆Standard of the product appearance test∶
 - a. Manner of appearance test :
 - (1). The test best be under 20W×2 fluorescent light , and distance of view must be at 30 cm.
 - (2). The test direction is base on about around 45° of vertical line.





\clubsuit Specification For TFT-LCD Module Less Than 3.5":

	Level Major	
	-	
	Major	
	Major	
ction.	Major	
tructure	Major	
	Major	
4. 2 No function or no display.		
4. 3 Display malfunction.		
4. 4 LCD viewing angle defect.		
	Major	
_		
	Minor	
een and		
blue screens. 5. 2 It is defined as dot defect if defect area $>1/2$ dot.		

(Ver.B01)



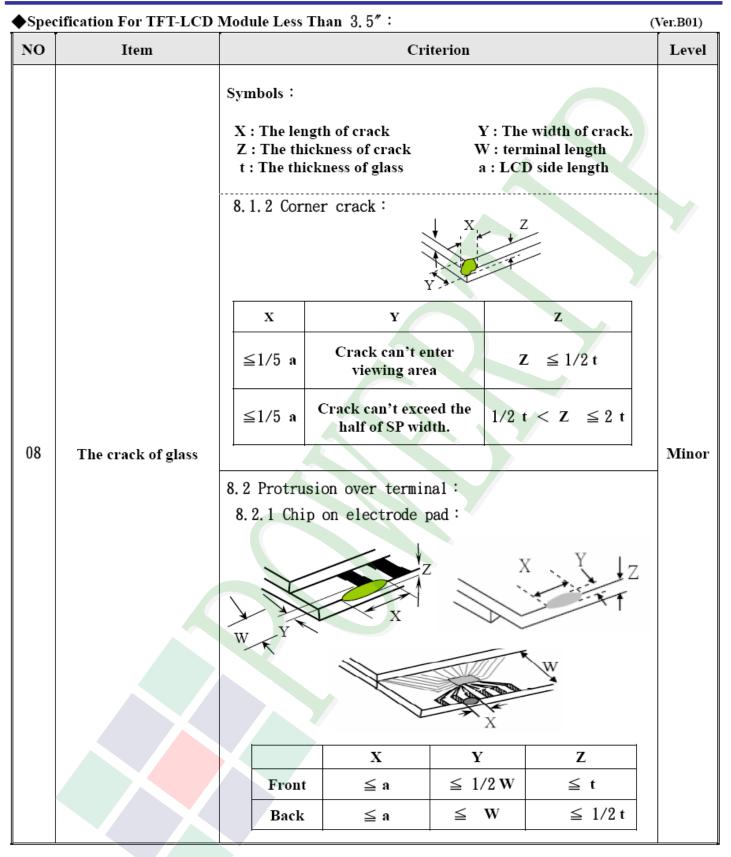
♦ Specification For TFT-LCD Module Less Than 3.5″:					
NO	Item	Criterion			Level
		6. 1 Round type (Non-display o	or display) :		
		Dimension (diameter :Φ)	Acceptanc		
	Black or white	$\Phi \le 0.15$	A area Ignore	B area	
	dot、scratch、 contamination	$0.15 \ < \ \Phi \leq 0.20$	2		
	Round type	$0.20 \ < \ \Phi \leq 0.30$	2	Ignore	
		$\Phi > 0.30$	0		
06	■ <u>Y</u>	Total	3		Minor
	$\Phi = (x+y)/2$	6. 2 Line type(Non-display or d	lisplay) :		
	Line type	Dimension	Accepta	nce (Q'ty)	
	⊥ine type ↓	Length (L) Width (W)	A area	B area	
		$$ $W \leq 0.$.03 Ignore		
		$\mathbf{L} \leq 5.0 0.03 \mathbf{W} \leq 0.03$	05 3	Imore	
		W >0.	.05 As round type	d Ignore	
		Total	3		
				1	
		Dimension	Acceptance	(Q'ty)	
		(diameter ÷ Φ)	A area	B area	
	Polarizer	$\Phi \leq 0.20$	Ignore		
07	Bubble	$0.20 < \Phi \leq 0.50$	3	Ignore	Minor
		$\Phi > 0.50$	0	-gnore	
		Total	3		
					<u> </u>



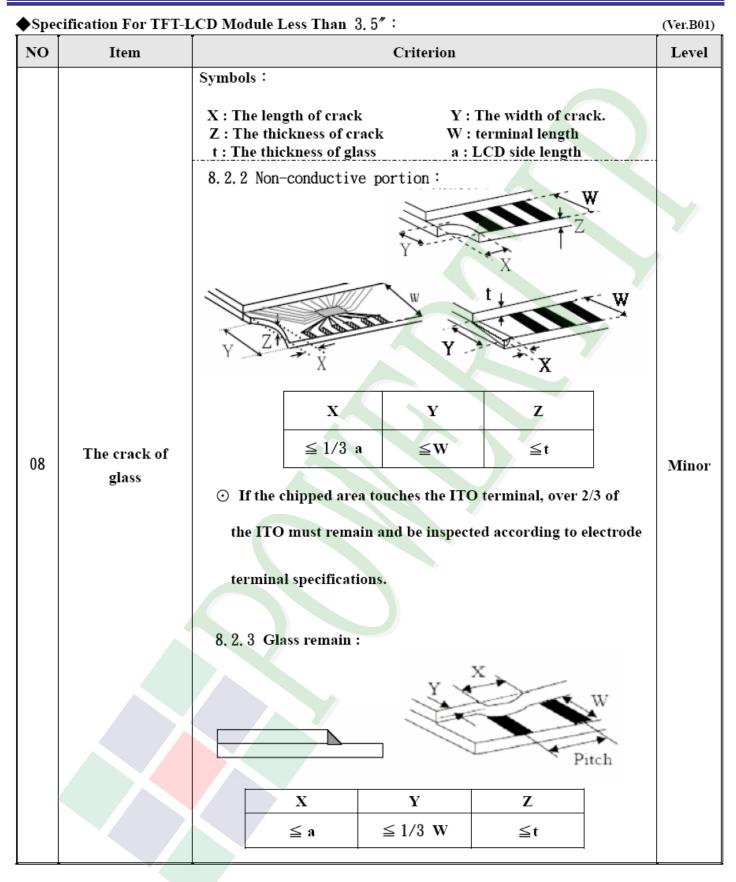
◆Specification For TFT-LCD Module Less Than 3.5″:

Specification For TFT-LCD Module Less Than 3.5": (V				
NO	Item	Criterion		Level
		Z : The thickness of crack	Y : The width of crack. W : terminal length a : LCD side length	
		8.1 General glass chip:		
		8.1.1 Chip on panel surface and cr	ack between panels:	
		X Y Z Z	Y	
08	The crack of glass		SP [NG]	Minor
		Seal width	Y	
		XY	Z	
		≤ a Crack can't enter viewing area	$\leq 1/2 t$	
		≤ a Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$	











◆Specification For TFT-LCD Module Less Than 3.5″:

◆Specification For TFT-LCD Module Less Than 3.5″:				
NO	Item	Criterion	Level	
09	Backlight elements	9. 1 Backlight can't work normally.	Major	
		9. 2 Backlight doesn't light or color is wrong.	Major	
		9. 3 Illumination source flickers when lit.	Major	
		10. 1 Pin type 、 quantity 、 dimension must match type in structure diagram.	Major	
		10. 2 No short circuits in components on PCB or FPC .	Major	
10	General	10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major	
10	арреагапсе	10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor	
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor	
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor	



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

	Renability Test Condi	uon (ver.but)
NO.	TEST ITEM	TEST CONDITION
1	High Temperature Storage Test	Keep in +80 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
2	Low Temperature Storage Test	Keep in -30 $\pm 2^{\circ}$ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
3	High Temperature / High Humidity Storage Test	Keep in +60 °C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)
4	Temperature Cycling Storage Test	$\begin{array}{cccccccccccccccccccccccccccccccccccc$
5	ESD Test	Air Discharge:Contact Discharge:Apply 2 KV with 5 timesApply 250 V with 5 timesDischarge for each polarity +/-discharge for each polarity +/-1. Temperature ambiance : 15°C ~35°C2. Humidity relative : 30%~60%3. Energy Storage Capacitance(Cs+Cd) : 150pF±10%4. Discharge Resistance(Rd) : 330 Ω±10%5. Discharge, mode of operation :Single Discharge (time between successive discharges at least 1 sec)(Tolerance if the output voltage indication : ±5%)
6	Vibration Test (Packaged)	 Sine wave 10 55 Hz frequency (1 min/sweep) The amplitude of vibration :1.5 mm Each direction (X \ Y \ Z) duration for 2 Hrs
7	Drop Test (Packaged)	Packing Weight (Kg) Drop Height (cm) 0 ~ 45.4 122 45.4 ~ 90.8 76 90.8 ~ 454 61 Over 454 46 Drop Direction :%1 corner / 3 edges / 6 sides each 1 time

POWERTIP

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320 ± 10 and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}C \pm 5^{\circ}C$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

